

Thermal transfer compounds

Ceramic filled, silicone-free thermal conductive paste with high thermal conductivity

- suitable especially for silicone-sensitive applications
- no drying out, hardening or melting of the thermal conductive paste
- high long-term stability
- further package sizes, container types such as cans, cartridge, etc. upon request



art. no.	basin	delivery quantity [ml]
WLPK 3	syringe	3
WLPK 5	syringe	5
WLPK 10	syringe	10

	WLPK
composition	silicone-free, synthetic fluid ceramic filled
consistance	paste
colour	silver
tightness	1.4 g/cm ³
thermal conductivity	10 W/m·K
dielectric strength	not applicable, because conducting
temperature range	-60 °C ... +150 °C
solubility in water	insoluble

Mica wafers
 Thermal conductive foil
 Thermal conductive paste
 Thermal conductive glue

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 → E 19 - 20
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Thermal conductive material
 Insulating caps
 Aluminium oxide wafers
 Technical introduction

→ E 2 - 5
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E 20

A

B

C

D

E

F

G

H

I

K

L

M

N